

Intel® Xeon® Scalable Processors, Intel® Xeon® W Processors and Intel® Xeon® E Processors for Professional Workstations



Optimized to Over-Deliver

Designed for professionals, workstations powered by Intel® Xeon® processors are the trusted platform for the next generation of professional product designers, content creators, and data scientists. With the ideal combination of processor power, memory, and Intel® Optane™ storage, Intel Xeon processor-based workstations enable you to create, test, and deliver solutions faster than ever.

Intel® Xeon® Processors provides maximum performance and uptimes for workstation workloads



WHAT MATTERS?

I can run applications easily and efficiently without getting bogged down

INTEL® XEON® PROCESSOR ADVANTAGES

Frequency optimized options from 4 to 28 core options, per processor, mean you spend more time creating and less time waiting



I can increase productivity by minimizing system downtown Professional-class processors designed and manufactured to perform in always-on usage scenarios



I can explore more possibilities by designing in 3D virtual reality Applications optimized for the vector processing capabilities of Intel® AVX-512 deliver significantly increased performance to drive complex, 3D CAD and content creation applications

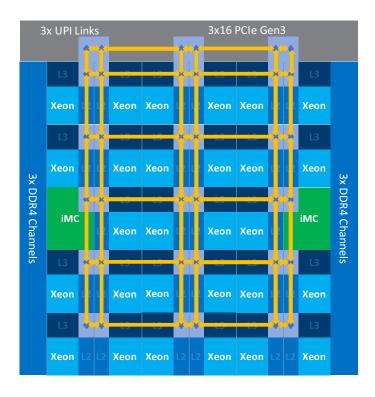


My designs and simulations are accurate

Error Correction Code (ECC) hardware circuitry built onto workstations powered by Intel® Xeon® processor tests for and corrects errors in your data as it passes in and out of memory

Pervasive, Breakthrough Performance

From its new Intel® Mesh Architecture and widely expanded resources to its hardware-accelerating technologies like Intel® AVX-512, Intel® Xeon® Scalable and Intel® Xeon® W processor-based workstation platforms enable a new level of breakthrough performance. Whether your application scales based on processor frequency or on the number of cores and threads, Intel Xeon processors provide a flexible range of options with processors up to 4.5 GHz or up to 28 cores.



In the Intel® Xeon® Scalable processor platform Intel® Mesh Architecture with up to 28 cores (per processor), the Last Level Cache (LLC), six memory channels, and 48 PCle* channels are shared among all the cores, giving access to large resources across the entire die and creating dynamic scalability without sacrificing performance.

Foundational Enhancements

- Higher Per-Core Performance or Higher Frequency Performance: Up to 28 cores and 56 threads, per processor, for Intel Xeon Scalable processors. Up to 18 cores and 36 threads for Intel Xeon W processors and up to 6 cores and 12 threads for Intel Xeon E processors delivering high performance and scalability for compute-intensive workstation workloads. For frequency-bound workstation applications, Intel Xeon E processors provide up to 4.7 GHz of frequency to drive increased performance.
- Expanded I/O: 48 lanes of PCIe* 3.0 bandwidth and throughput for demanding I/O-intensive workloads.
- Intel® Advanced Vector Extensions 512 (Intel® AVX-512): With double the flops per clock cycle compared to previous generation Intel® AVX2,¹ Intel® AVX-512 boosts performance and throughput for the most demanding computational tasks in applications, such as modeling and simulation, data analytics and machine learning, visualization, and digital content creation.

Essential Workstation Features

- Error correcting code (ECC): Error correcting code, or ECC memory, automatically detects and repairs single-bit errors on-the-fly to keep workstation applications running reliably and free of data corruption.
- Intel® Turbo Boost Technology 2.0: Dynamically increases the processor's frequency, as needed, by taking advantage of thermal and power headroom when operating below specified limits.
- Intel® Hyper-Threading Technology: Delivers two processing threads per physical core. Highly threaded applications can get more work done in parallel, completing tasks sooner.
- Intel® Speed Shift Technology: Delivers dramatically quicker responsiveness with single-threaded, transient (short duration) workloads by allowing the processor to more quickly select its best operating frequency and voltage for optimal performance and power efficiency.
- Intel® vPro™ Technology: Intel® vPro™ Technology delivers hardware-enhanced security, identity protection, and remote manageability to ease workstation deployment for IT managers.
- Integrated Intel® Ethernet: Intel 1 Gigabit Ethernet provides high-bandwidth access to simulation, rendering, or analytics servers.

Intel Xeon Scalable Processors Deliver World Class Performance for Expert Workstation Professionals

Intel Xeon Scalable Processors deliver breakthrough performance for photorealistic design, modeling, and content creation done in real-time. Stunning professional quality VR experiences immerse the creator into the design, simulation, animation, and video.

With up to 28 cores at 3.8 GHz or 6 cores at 4.2 GHz, per processor, the Intel Xeon Scalable processor delivers dual-socket, world class performance, to a broad range of workstation applications.



Intel Xeon Scalable processors are ready for **expert-level professional quality VR**, a revolution in design and content creation delivering the experience of real life in real time.

EXPERT WORKSTATION PERFORMANCE



2018 Dual-Socket Intel® Xeon® Scalable Processor vs. 2016 Dual-Socket Intel® Xeon® E5-2600 v4 Processors

UP TO 1.55X FASTER²

Intel Xeon W Processors Deliver Optimized Performance for Mainstream Workstation Professionals

The new Intel Xeon W processors are based on the Intel Xeon Scalable processor microarchitecture, but designed into a cost-optimized one-socket form factor specifically for professional workstations.

With up to 18 cores at 4.3 GHz or 4 cores at 4.5 GHz, Intel Xeon W processors deliver optimized performance whether your workstation application scales best with increased processor core count or with increased processor frequency. With Intel® Turbo Boost Technology, you can further boost performance for frequency-bound applications.



Intel Xeon W processors are ready for **professional quality VR**. Experience the difference in design and product/service development using a professional quality VR solution.

MAINSTREAM WORKSTATION PERFORMANCE



2018 Intel® Xeon® W Processor vs. 2016 Intel® Xeon® E5-1500 v4 Processor

1.45X FASTER³

Intel Xeon E Processors Deliver Essential Performance and Built-In Visuals for Entry Workstation Professionals

The Intel Xeon E processor delivers enhanced performance, reliability and advanced security for the increasing demands and workflows of professional CAD, media and mobile workstations customers. Improvements in processor speed, enhanced memory capabilities, advanced hardware-enhanced security and reliability features available with support for 4K UHD Intel® graphics technology.

With up to 6 cores and frequencies up to 4.7 GHz, the Intel Xeon E processor delivers enhanced performance for frequency-bound workstation applications. Optimized Intel® UHD Graphics P630 drivers are available at downloadcenter.intel.com.



Intel Xeon E processors are ready for entry-level professional quality VR. Experience the difference in design and product/service development using a professional quality VR solution.

ENTRY WORKSTATION PERFORMANCE



2018 Intel® Xeon® E Processor vs. 2017 Intel® Xeon® E3-1200 v6 Processor.

1.36X FASTER⁴

Professional Workstation Storage Support

A balanced workstation platform goes beyond just raw compute, memory, and network performance. Storage innovations can drive significant improvements in efficiency and performance of data-hungry workloads. Intel Xeon Scalable processors, the Intel Xeon W processors, and Intel Xeon E processors feature key storage enhancements.

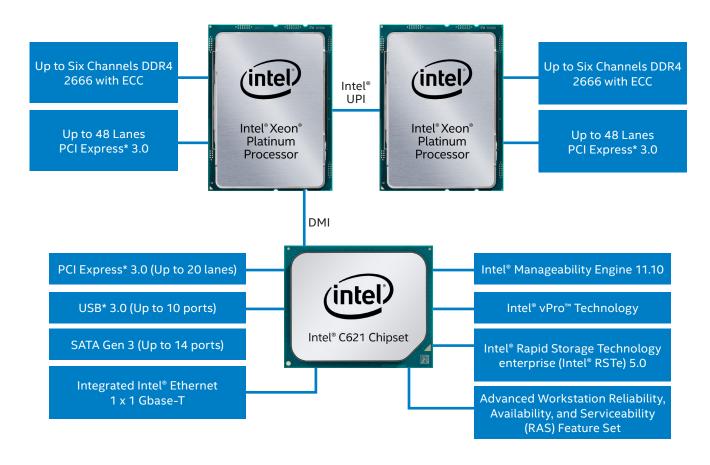
- Support for Intel® Optane™ DC SSDs and Intel® 3D NAND Solid State Drives: Delivers an enhanced combination of high throughput, low latency, high QoS, and ultra-high endurance to break through data access bottlenecks.
- Support for Intel® Optane™ memory: Enjoy a faster, smoother, and amazingly responsive computing experience with Intel® Optane™ memory, a smart, adaptable system accelerator, now for Intel® Xeon® E-2100 processor-based entry workstations.

- Intel® Software for Storage: Optimizes storage hardware, such as encryption, for increased storage performance.
 - Intel® Virtual RAID on Chip (Intel® VROC): Directly attach NVMe* SSDs to the CPU PCIe lanes to unleash NVMe* RAID performance at low power and low TCO.
 - Intel® Rapid Storage Technology (Intel® RSTe) for SATA RAID SSDs: Dynamic storage accelerator accelerates the performance of your SSD by dynamically adjusting system power management policies to deliver percent faster performance during heavy multitasking compared to default power management.
 - Intel® Cache Acceleration Software (Intel® CAS):
 Combined with Intel® Solid State Drives, Intel® CAS interoperates with system memory to create a multilevel cache that automatically determines the best cache level for active data.

Workstation Features

| | Intel® Xeon® E Processor (2100 Series) | Intel® Xeon® W Processor (2100 Series) | Intel® Xeon® Gold Processor (6100 Series) | Intel® Xeon® Platinum Processor (8100 Series) |
|--|--|--|---|---|
| Highest Core Count Supported (Per Processor) | 6 cores | 18 cores | 22 cores | 28 cores |
| Highest Supported Base Frequency | 3.8 GHz (6C/95W) | 4.0 GHz (4C/120W) | 3.4 GHz (6C/115W) | 3.6 GHz (4C/105W) |
| Number of CPU Sockets | 1 | 1 | 2 | 2 |
| Intel® UPI | N/A | N/A | 3 | 3 |
| Intel® UPI Speed | N/A | N/A | 10.4 GT/s | 10.4 GT/s |
| Intel® AVX-512 | not supported | 2 FMA | 2 FMA | 2 FMA |
| Memory Speed Support (DDR4) | 2666 MHz | 2666 MHz | 2666 MHz | 2666 MHz |
| Highest Memory Capacity Supported Per Socket | 64 GB | 512 GB | 768 GB, 1.5 TB | 768 GB, 1.5 TB |
| Memory Channels | 2 | 4 | 6 | 6 |
| Error Correcting Code (ECC) Memory Support | • | • | • | |
| PCIe 3.0 | • | | • | |
| Intel® Turbo Boost Technology 2.0 | • | | • | |
| Intel® Hyper-Threading Technology | • | • | • | |

Typical Intel® Xeon® Scalable Platform Dual-Socket Configuration



Processors, chipset, and diagram provided for illustration purposes only.

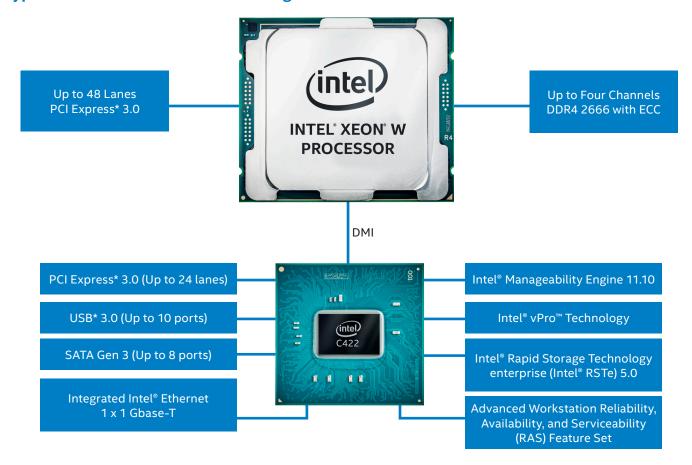
Not comprehensive of all features and capabilities.

Intel® Xeon® Scalable Processor SKUs and Chipset

| skus | | | | | | | |
|---------------|---------------|------------------|---|----------------|---------|--------------------------|--|
| SKU | Cores/Threads | Base Speed (GHz) | Max Intel® Turbo Boost Technology 2.0 Speed (GHz) | Intel® AVX-512 | TDP (W) | Last Level Cache (MB) | |
| Platinum 8180 | 28/56 | 2.5 | 3.8 | 2 512-bit FMA | 205 | 38.5 | |
| Platinum 8168 | 24/48 | 2.7 | 3.7 | 2 512-bit FMA | 205 | 33 | |
| Platinum 8158 | 12/24 | 3.0 | 3.7 | 2 512-bit FMA | 150 | 24.75 | |
| Platinum 8156 | 4/8 | 3.6 | 3.7 | 2 512-bit FMA | 105 | 16.5 | |
| Gold 6152 | 18/36 | 3.0 | 3.7 | 2 512-bit FMA | 200 | 24.75 | |
| Gold 6152 | 22/44 | 2.1 | 3.7 | 2 512-bit FMA | 140 | 30.25 | |
| Gold 6148 | 20/40 | 2.4 | 3.7 | 2 512-bit FMA | 150 | 27.5 | |
| Gold 6146 | 12/24 | 3.2 | 4.2 | 2 512-bit FMA | 165 | 24.75 | |
| Gold 6144 | 8/16 | 3.5 | 4.2 | 2 512-bit FMA | 150 | 24.75 | |
| Gold 6128 | 6/12 | 3.4 | 3.7 | 2 512-bit FMA | 115 | 19.25 | |

| PRODUCT NAME | USB 3.0 | SATA* Gen 3 | PCle* Gen 3 | Intel® Ethernet | DMI |
|---------------------|----------|-------------|-------------|-----------------|----------|
| Intel® C621 Chipset | 10 ports | 14 ports | 20 lanes | 1 x 1 Gbase-T | x4 Gen 3 |

Typical Intel® Xeon® W Platform Configuration



Processors, chipset, and diagram provided for illustration purposes only.

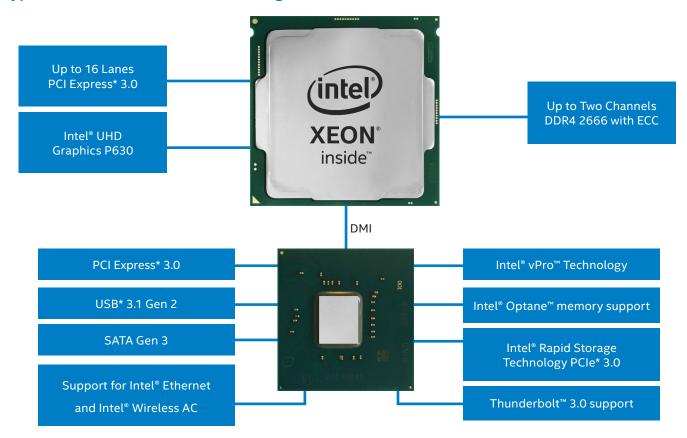
Not comprehensive of all features and capabilities.

Intel® Xeon® W Processor SKUs and Chipset

| SKUS SKUS | | | | | | | |
|-----------|-------|------------------|---|----------------|---------|--------------------------|--|
| sku | Cores | Base Speed (GHz) | Max Intel® Turbo Boost Technology 2.0 Speed (GHz) | Intel® AVX-512 | TDP (W) | Last Level Cache (MB) | |
| W-2195 | 18 | 2.3 | 4.3 | 2 512-bit FMA | 140 | 24.75 | |
| W-2175 | 14 | 2.5 | 4.3 | 2 512-bit FMA | 140 | 19.25 | |
| W-2155 | 10 | 3.3 | 4.5 | 2 512-bit FMA | 140 | 13.75 | |
| W-2145 | 8 | 3.7 | 4.5 | 2 512-bit FMA | 140 | 11 | |
| W-2135 | 6 | 3.7 | 4.5 | 2 512-bit FMA | 140 | 8.25 | |
| W-2133 | 6 | 3.6 | 3.9 | 2 512-bit FMA | 140 | 8.25 | |
| W-2125 | 4 | 4.0 | 4.5 | 2 512-bit FMA | 120 | 8.25 | |
| W-2123 | 4 | 3.6 | 3.9 | 2 512-bit FMA | 120 | 8.25 | |

| PRODUCT NAME | USB 3.0 | SATA* Gen 3 | PCle* Gen 3 | Intel® Ethernet | DMI |
|---------------------|----------|-------------|-------------|-----------------|---------|
| Intel® C422 Chipset | 10 ports | 8 ports | 24 lanes | 1 x 1 Gbase-T | x4 Gen3 |

Typical Intel® Xeon® E Platform Configuration



Processors, chipset, and diagram provided for illustration purposes only.

Not comprehensive of all features and capabilities.

Intel® Xeon® E Processor SKUs and Chipset

| SKUS | | | | | | | |
|-----------|-------|------------------|---|-----------------------------|---------|-------------------------|--|
| SKU | Cores | Base Speed (GHz) | Max Intel® Turbo Boost Technology 2.0 Speed (GHz) | Intel® UHD Graphics P630 | TDP (W) | Processor Cache (MB) | |
| E-2186G | 6 | 3.8 | 4.7 | Yes | 95 | 12 | |
| E-2176G | 6 | 3.7 | 4.7 | Yes | 80 | 12 | |
| E-2174G | 4 | 3.8 | 4.7 | Yes | 71 | 8 | |
| E-2146G | 6 | 3.5 | 4.5 | Yes | 80 | 12 | |
| E-2144G | 4 | 3.6 | 4.5 | Yes | 71 | 8 | |
| E-2136 | 6 | 3.3 | 4.5 | No | 80 | 12 | |
| E-2134 | 4 | 3.5 | 4.5 | No | 71 | 8 | |
| E-2126G** | 6 | 3.3 | 4.5 | Yes | 80 | 12 | |
| E-2124G** | 4 | 3.4 | 4.5 | Yes | 71 | 8 | |
| E-2124** | 4 | 3.3 | 4.3 | No | 71 | 8 | |

| PRODUCT NAME | USB 3.1/3.0 | SATA* Gen 3 | PCle* Gen 3 | Intel® Ethernet and Intel® Wireless | DMI |
|------------------------------------|------------------|-------------|--------------------------|--|---------|
| Intel® C246 Workstation Chipset | 6 ports/10 ports | 8 ports | 40 lanes (CPU + Chipset) | Supported | x4 Gen3 |

Visit intel.com/xeone for a complete list of available Intel® Xeon® E processors.

^{**}Intel® Xeon® E-2126G, E-2124G, and E-2124 processors do not support Intel® Hyper-Threading Technology (Intel® HT technology)



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Notice Revision #20110804.

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1 As measured by Intel® Xeon® Processor Scalable Family with Intel® AVX-512 compared to an Intel® Xeon® E5 v4 with Intel® AVX2.

² Up to 1.55X faster vs. 2016 Dual-Socket Intel® Xeon® E5-2600 v4 Processors. Configuration: Estimates based on Intel internal testing as of June 2018 on SPECint® rate base2006: 1-Node, 2 x Intel® Xeon® Platinum 8180M Processor on Wolf Pass SKX with 384 GB Total Memory on Red Hat Enterprise Linux® 7.4 using Benchmark software: SPEC CPU® 2017; Compiler: Intel® Compiler IC18 OEM, Optimized libraries: AVX512. Data Source: Request Number: 40, Benchmark: SPECrate® 2017_int_base (estimated), Score: 281 Higher is better vs. 1-Node, 2 x Intel® Xeon® Processor E5-2699 v4 on Wildcat Pass with 256 GB Total Memory on Red Hat Enterprise Linux® 7.4 using Benchmark software: SPEC CPU® 2017 v1.2, Optimized libraries: IC18.0_20170901, Other Software: MicroQuill SMART HEAP, Script / config files: xCORE-AVX2. Data Source: Request Number: 40, Benchmark: SPECrate® 2017_int_base(estimated), Score: 181 Higher is better.

³ Up to 1.45X faster vs. 2016 Intel® Xeon® E5-1600 v4 Processor. Configuration: Estimates based on Intel internal testing as of June 2018 on 1x Intel® Xeon® W-2155 Processor, Platform: BSF, 4x 32GB DDR4 2666 MHz, OS: Ubuntu 17.10 (Kernel 4.13.0-30-generic), Benchmark: SPECrate*2017_int_base (Estimated), Compiler: ICC 18.0.2,BIOS: BSFSWSR1.R00.X060.B42.1802230717 or 12.2/2/2018, (uCode: 0x2000043), SNC enabled, IMC 2-way interleaving, Storage: SSD S3710 Series 400 GB, Score: 70.5 vs 1x Intel® Xeon® Processor E5-1680 v4, Platform: Supermicro X10SRA, 4x 32GB DDR4 2400 MHz, OS: Ubuntu 17.10 (Kernel 4.13.0-35-generic), Benchmark: SPECrate*2017_int_base (Estimated), Compiler: ICC 18.0.2,BIOS: American Megatrends Inc. 2.1 03/29/2018, (uCode: 0xb000002a), Storage: SSD S3710 Series 800 GB, Score: 48.4.

⁴ Up to 1.36X faster vs. 2017 Intel® Xeon® E3-1200 v6 Processor. Configuration: Estimates based on Intel internal testing as of June 2018 on 1x Intel® Xeon® E-2186G Processor, Platform: Moss Beach, 4 x 8GB DDR4 2666 ECC (32 GB 2666 MHz), QS: Ubuntu 17.10 (Kernel 4.13.0-35-generic), Benchmark: SPECrate2017_int_base (Estimated), Compiler: ICC 18.0.2,BIOS: CNLSE2R1.R00. X119.B54.1803131307, 03/13/2018 (uCode: 0x84), Storage: SSD S3710 Series 800 GB, Score: 40.9 compared to 1x Intel® Xeon® Processor E3-1285 v6, Platform: S1200SP, 4 x 8 GB DDR4 2400 MHz, OS: Ubuntu 17.10 (Kernel 4.13.0-35-generic), Benchmark: SPECrate2017_int_base (Estimated), Compiler: ICC 18.0.28, BIOS: S1200SP.86B.03.01.1029.012520180838 (uCode:0x84), Storage: SSD S3710 Series 800 GB, Score: 29.9.

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